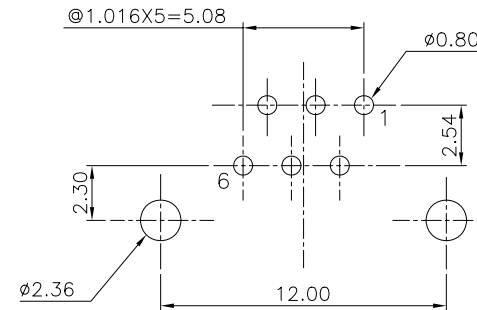
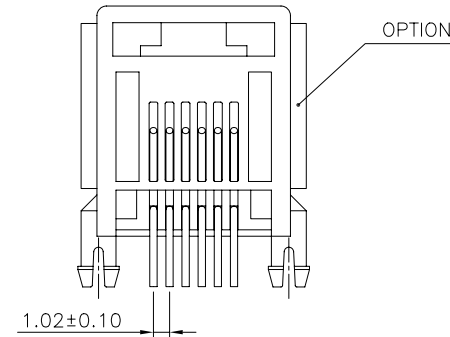
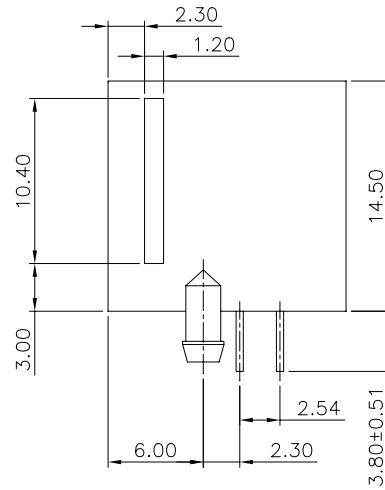
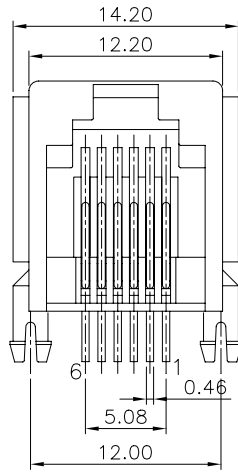


| REVISION RECORD | | | | |
|-----------------|-----|-------------|------------------|------|
| REV | ECO | DESCRIPTION | DRFT | CHKD |
| △ | | ADD P/N. | HERO 12/08/05 | |



PC Board Layout Component Side Shown

NOTES:

ELECTRICAL:

1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 30 MILLIOHMS MAX.
4. INSULATION RESISTANCE: 1000 MEGOHMS MIN @ 500 VDC.
5. DIELECTRIC STRENGTH : 1000 VAC RMS 60Hz, 1MIN.

MECHANICAL:

1. HOUSING MATERIAL : NYLON+30%.G.F(FR52) UL94V-0.
2. CONTACT MATERIAL : PHOSPHOR BRONZE ϕ 0.46mm.
3. PLATING : GOLD PLATING OVER NICKEL.
4. OPERATING LIFE : 750 CYCLES MIN.
5. PCB RETENTION PRE-SOLDER : 1 LB MIN.
6. PCB RETENTION POST-SOLDER: 10 LBS MIN.

ENVIRONMENTAL:

1. STORAGE : -40°C TO +85°C.
 2. OPERATION: -40°C TO +85°C.
 3. WAVE SOLDERING TEMPERATURE 255~265°C (5~10SECONDS)
- FCC PART 68, SUBPART F.

CUL FILE NO. E163191

PART NUMBER: E556X-00LXXX-L

- | | | |
|------|--------|-----------|
| 2-2C | 1- 3u" | 2- 6u" |
| 4-4C | 3-15u" | 4-30u" |
| 6-6C | 5-50u" | 6-Pd 20u" |

- U1-W/ Panel Stop FR52BK
- U2-W/O Panel Stop FR52BK
- UM-W/ Panel Stop FR52GY △

| | | | | | |
|------------------------|----------------------------|---------------|-------------|-------------------------|---|
| DETACHED LISTS | ← MM (INCH) → | | DFTO CXQ | DATE 04/27/05 | FULL RISE ELECTRONIC CO., LTD TITLE SIDE ENTRY L/P PCB JACK |
| | TOLERANCES EXCEPT AS NOTED | | CHKD | DATE | |
| | | | MFO | DATE | |
| | | | APPVL OSCQR | DATE 12/12/05 | |
| MM | | ± | MATERIAL : | | |
| .0 ±0.20 | | ± | ANGLES ± | | |
| .00 ±0.15 | | ± | QT'Y : | | |
| .000 ±0.075 | | ± | FINISH : | | |
| THIRD ANGLE PROJECTION | | SCALE : 3 : 1 | | DRAWING NO. GE553007-LA | |
| DO NOT SCALE DRAWING | | | | SHEET X | OF Y |

| | | |
|-------------------------|---------|-------|
| DRAWING NO. GE553007-LA | SIZE A3 | REV 1 |
| /PART NO. SEE NOTE | | |